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## Product Change Notification - CYER-21JXDZ485

Date:	03 Aug 2011
Product Category:	Memory
Device Family:	
Notification subject:	CCB 1072: Qualification of certain catalog part numbers in the 8L SOIJ package with 8006NS die attach at MTAI assembly site.
Notification text:	PCN Status: Initial notification
	Microchip Parts Affected: See attachments of affected catalog part numbers (CPN) labeled as PCN_CYER-21JXDZ485_Affected_CPN.xls PCN_CYER-21JXDZ485_Affected_CPN.pdf
	Description of Change: Qualification of certain catalog part numbers in the 8L SOIJ package with 8006NS die attach at MTAI assembly site.
	Pre Change: 8390A die attach
	Post Change: 8006NS die attach
	Impacts to Data Sheet: None
	Reason for Change: To improve manufacturability
	Change Implementation Status: In Progress
	Estimated First Ship Date: October 28, 2011 (date code: 1144)
	NOTE: Please be advised that during the transition period customers may receive pre and post change parts, due to existing inventory of the pre changed parts.
	Markings to Distinguish Revised from Unrevised Devices: Traceability code
	Revision History: August 4, 2011: Issued initial notification.
Attachment(s):	PCN_CYER-21JXDZ485_Affected_CPN.pdf PCN_CYER-21JXDZ485_Affected_CPN.xls PCN_CYER-21JXDZ485_Qual Plan.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Parts Affected

24AA1025 24FC1025 24LC1025